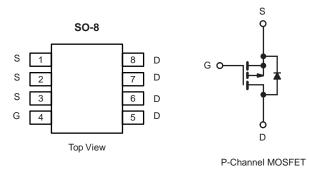


## **UPA1731GR-VB** Datasheet P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)			
- 30	0.011 at V <sub>GS</sub> = - 10 V	- 11.6	22 nC			
- 30	0.012 at V <sub>GS</sub> = - 4.5 V	- 10	22 110			



### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested

#### **APPLICATIONS**

- Load Switches
- Notebook PCs
  - Desktop PCs



COMPLIANT HALOGEN

FREE Available

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	- 30	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20		
	T <sub>C</sub> = 25 °C		- 11.6		
Continuous Drain Current (T $= 150$ °C)	T <sub>C</sub> = 70 °C		- 10.5		
Continuous Drain Current ( $T_J = 150 \ ^\circ C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 8.7 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		- 7.7 <sup>a, b</sup>		
Pulsed Drain Current	I <sub>DM</sub>	- 40	— A		
Ocational Designation	T <sub>C</sub> = 25 °C		- 4.6		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.0 <sup>a, b</sup>		
Avalanche Current	1 0.4 ml l	I <sub>AS</sub>	- 20		
Single-Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		5.6	w	
Mauianum Danna Diagia atian	T <sub>C</sub> = 70 °C		3.6		
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		1.6 <sup>a, b</sup>		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	39	50	°C/W		
Maximum Junction-to-Foot	Steady State	R <sub>thJF</sub>	18	22	·C/W		

Notes:

a. Surface mounted on 1" x 1" FR4 board.

c. Maximum under Steady State conditions is 85 °C/W. d. Based on  $T_C = 25$  °C.

b. t = 10 s.

<b>B</b> <sup>®</sup> VBsemi					
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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-					<b></b>	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = -250 \mu A$	- 30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			- 31		- mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		5.5			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.0		- 3.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 25 V$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$			- 1 - 5	μA	
		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ C}$ $V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	- 30		- 5	А	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{\rm DS} = -10$ V, $V_{\rm GS} = -10$ V V <sub>GS</sub> = -10 V, I <sub>D</sub> = -10 A	- 30	0.011		~	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -7 \text{ A}$		0.011		Ω	
Farmend Transconductors	<b>Q</b> .	$V_{GS} = -4.5 V, I_D = -7 A$ $V_{DS} = -10 V, I_D = -10 A$		0.012 23		S	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	VDS = - 10 V; ID = - 10 K		23		3	
Dynamic <sup>b</sup>	<u> </u>			1960		1	
Input Capacitance	C <sub>iss</sub> C <sub>oss</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		380		~ -	
Output Capacitance		$v_{\rm DS} = -13 v, v_{\rm GS} = 0 v, t = 10012$				pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			325	05		
Total Gate Charge	Qg	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 10 A		43 22	65 33	-	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 10 A		6		nC	
Gate-Drain Charge	Q <sub>gd</sub>			11		-	
Gate Resistance	R <sub>q</sub>	f = 1 MHz	0.3	1.3	2.5	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			11	22		
Rise Time	tr	$V_{DD}$ = - 15 V, $R_L$ = 3 $\Omega$		13	25		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 5 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		32	50		
Fall Time	t <sub>f</sub>			9	18		
Turn-On Delay Time	t <sub>d(on)</sub>			44	70	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, R <sub>L</sub> = 3 $\Omega$		100	160	-	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 5 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		28	50		
Fall Time	t <sub>f</sub>			15	30		
Drain-Source Body Diode Characterist	ics						
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 4.6	٨	
Pulse Diode Forward Current	I <sub>SM</sub>				- 50	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 2 A, V <sub>GS</sub> = 0 V		- 0.75	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			28	45	ns	
Body Diode Reverse Recovery Charge		$\frac{Q_{rr}}{t_a}$ I <sub>F</sub> = - 2 A, dl/dt = 100 A/µs, T <sub>J</sub> = 25 °C		20	40	nC	
Reverse Recovery Fall Time				13			
Reverse Recovery Rise Time	t <sub>b</sub>			15		ns	

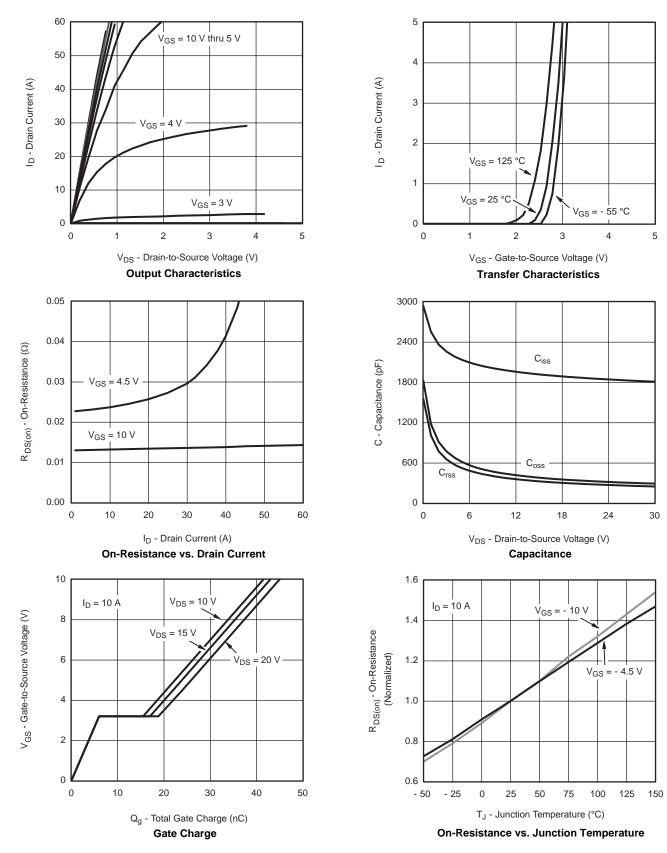
Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

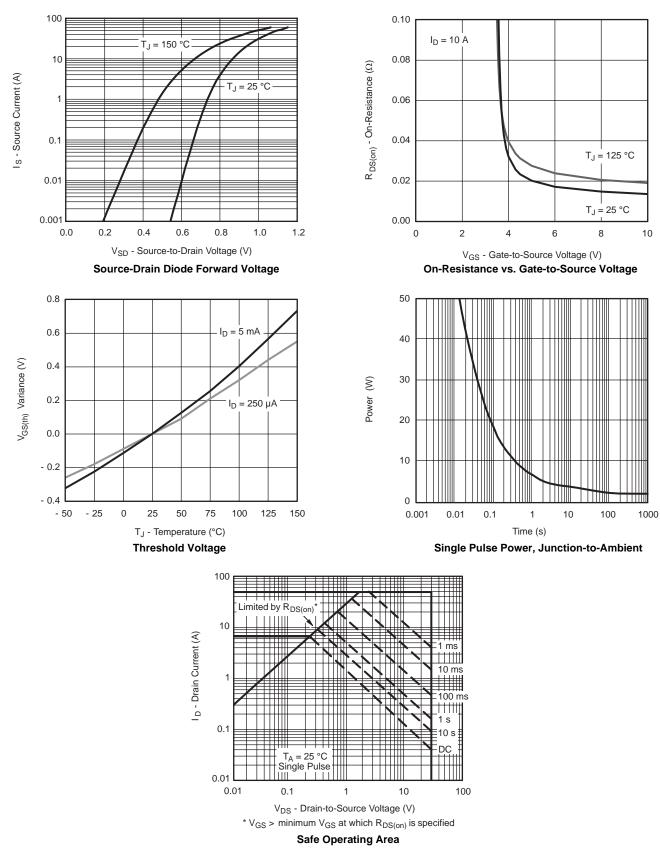
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



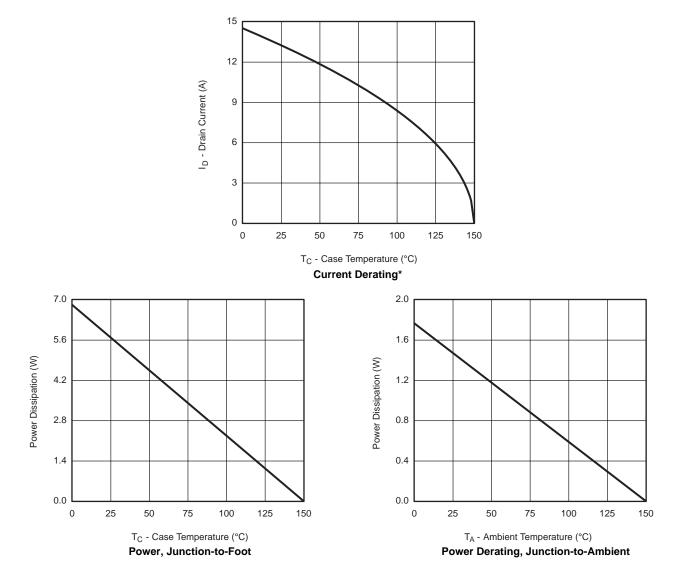


服务热线:400-655-8788



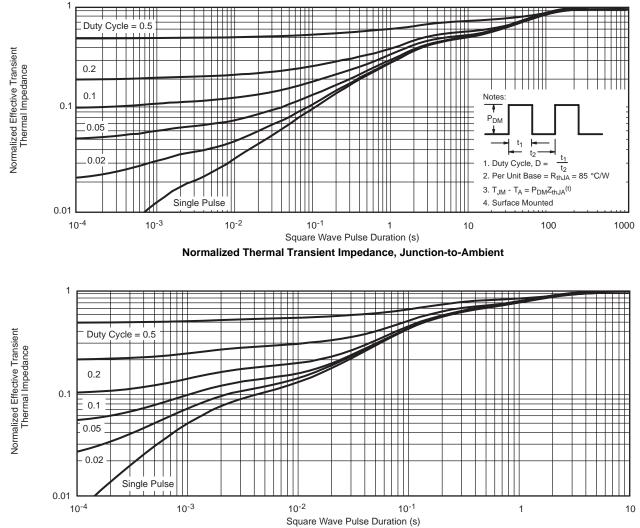






\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





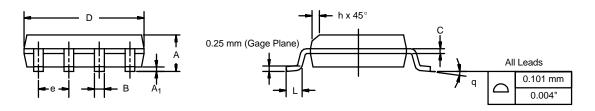
Normalized Thermal Transient Impedance, Junction-to-Foot



## SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





	MILLIMETERS		INC	HES	
DIM	Min	Max	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
e	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



#### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)



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